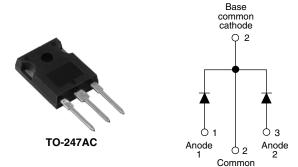


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Schottky Rectifier, 2 x 20 A

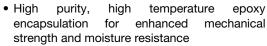


PRODUCT SUMMARY						
Package	TO-247AC					
I _{F(AV)}	2 x 20 A					
V_{R}	15 V					
V _F at I _F	0.34 V					
I _{RM} max.	600 mA at 100 °C					
T _J max.	125 °C					
Diode variation	Common cathode					
E _{AS}	5 mJ					

cathode

FEATURES

- 125 °C T_J operation (V_R < 5 V)
- Optimized for OR-ing applications
- Ultralow forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability





- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)



DESCRIPTION

The VS-MBR40L15CW... center tap Schottky rectifier module has been optimized for ultralow forward voltage drop specifically for the OR-ing of parallel power supplies. The proprietary barrier technology allows for reliable operation up to 125 °C junction temperature. Typical applications are in parallel switching power supplies, converters, reverse battery protection, and redundant power subsystems.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL CHARACTERISTICS VALUES UNIT								
I _{F(AV)}	Rectangular waveform	40	A					
V _{RRM}		15	V					
I _{FSM}	t _p = 5 μs sine	700	A					
V _F	20 Apk, T _J = 125 °C (per leg, typical)	0.26	V					
TJ	Range	- 55 to 125	°C					

VOLTAGE RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VS-MBR40L15CWPbF	VS-MBR40L15CW-N3	UNITS		
Maximum DC reverse voltage	V_R	T ₁ = 100 °C	15	15	V		
Maximum working peak reverse voltage	V_{RWM}	1J = 100 C	15	15	V		

ABSOLUTE MAXIMUM RATINGS								
PARAMETER		SYMBOL	TEST CONDITIONS		VALUES	UNITS		
Maximum average forward current	per leg		50 % duty cycle, at T _C = 86 °C, rectangular waveform		FO 0/ duty ovels at T = 96 °C rectangular waveform		20	
See fig. 5	per device	I _{F(AV)}			40	Α		
Maximum peak one cycle			5 μs sine or 3 μs rect. pulse	Following any rated load condition and with	700	A		
non-repetitive surge current per leg See fig. 7		I _{FSM}	10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	330			
Non-repetitive avalanche en	petitive avalanche energy per leg E_{AS} $T_J = 25 ^{\circ}C$, $I_{AS} = 2$ A, L = 6 mH		5	mJ				
Repetitive avalanche current	per leg	I _{AR}	I_{AR} Current decaying linearly to zero in 1 μs Frequency limited by T_J maximum $V_A = 1.5$ x V_R typical		2	Α		

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ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST COND	DITIONS	TYP.	MAX.	UNITS	
		20 A	T _{.1} = 25 °C	1	0.42	V	
Maximum forward voltage drop per leg	V _{FM} ⁽¹⁾	40 A	11 = 23 0	-	0.52		
See fig. 1	V _{FM} (')	20 A	T _{.1} = 125 °C	0.26	0.34]	
		40 A	1J = 125 C	0.37	0.50		
Reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V DetectV	-	10	mA	
See fig. 2	IRM (1)	T _J = 100 °C	V _R = Rated V _R	-	600	IIIA	
Threshold voltage	V _{F(TO)}	T T manyimum		0.1	182	V	
Forward slope resistance	r _t	$T_J = T_J$ maximum		7.6		mΩ	
Maximum junction capacitance per leg	C _T	V _R = 5 V _{DC} , (test signal range 100 kHz to 1 MHz) 25 °C			2000	pF	
Typical series inductance per leg	L _S	Measured lead to lead 5 mm from package body			-	nH	
Maximum voltage rate of change	dV/dt	Rated V _R 10 000			000	V/µs	

Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction temperature range	T_J		- 55 to 125	°C			
Maximum storage temperature range	T _{Stg}		- 55 to 150	10			
Maximum thermal resistance, junction to case per leg	В	DC operation See fig. 4	1.4				
Maximum thermal resistance, junction to case per package	- R _{thJC}	DC operation	0.7	°C/W			
Typical thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth and greased	0.24				
Approximate weight			6	g			
Approximate weight			0.21	OZ.			
Mounting torque minimum		Non-lubricated threads	6 (5)	kgf ⋅ cm			
Mounting torque — maximum		Non-lubricated trireads	12 (10)	(lbf \cdot in)			
Marking device		Case style TO-247AC (JEDEC)	MBR40	L15CW			

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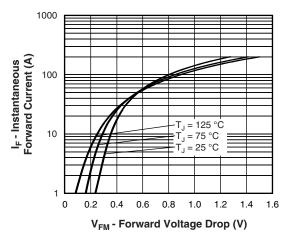


Fig. 1 - Maximum Forward Voltage Drop Characteristics

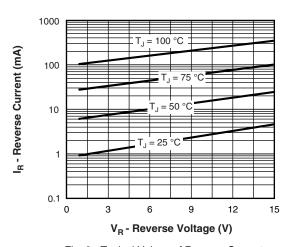


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

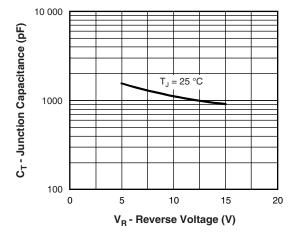


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

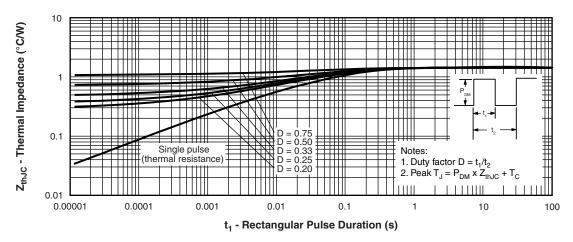


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



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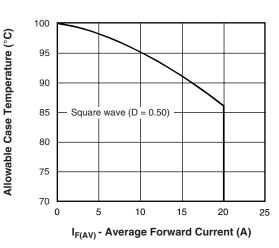


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

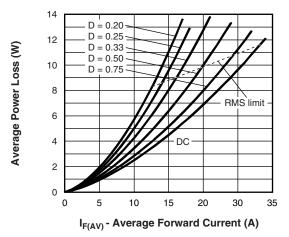


Fig. 6 - Forward Power Loss Characteristics

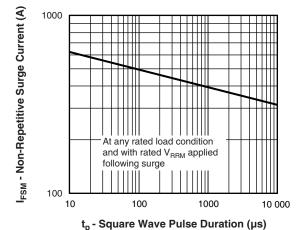


Fig. 7 - Maximum Non-Repetitive Surge Current

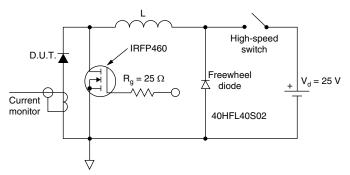
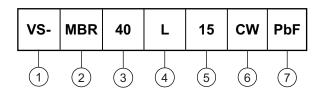


Fig. 8 - Unclamped Inductive Test Circuit

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Schottky MBR series

3 - Current rating (40 = 40 A)

L = Low forward voltage

Voltage rating (15 = 15 V)

6 - Circuit configuration:

Center tap TO-247

7 - Environmental digit

• PbF = Lead (Pb)-free and RoHS compliant

• -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

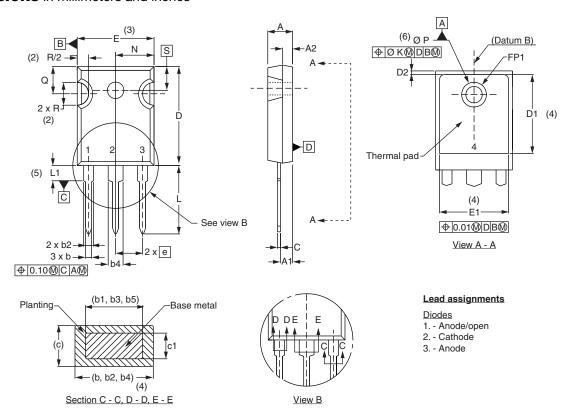
ORDERING INFORMATION (Example)								
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION								
VS-MBR40L15CWPbF	25	500	Antistatic plastic tube					
VS-MBR40L15CW-N3	25	500	Antistatic plastic tube					

LINKS TO RELATED DOCUMENTS						
Dimensions www.vishay.com/doc?95223						
Dark mandring information	TO-247AC PbF	www.vishay.com/doc?95226				
Part marking information	TO-247AC -N3	www.vishay.com/doc?95007				



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DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.37	0.065	0.094	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.86	0.015	0.034	
c1	0.38	0.76	0.015	0.030	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	IETERS	INC	NOTES	
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.72	-	0.540	-	
е	5.46	BSC	0.215	BSC	
FK	2.	2.54		0.010	
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
N	7.62	BSC	0.3		
ΦР	3.56	3.66	0.14	0.144	
ФР1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	1.78	0.216	
S	5.51	BSC	0.217	'BSC	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC outline TO-247 with exception of dimension c



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